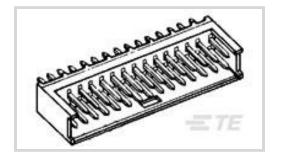
280521-1 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 280521-1 PCB Mount Header, Vertical, Board-to-Board, 24 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 24

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Partially Shrouded



Sealable	No				
Connector & Contact Terminates To	Printed Circuit Board				
Configuration Features					
Connector Contact Load Condition	Fully Loaded				
PCB Mount Orientation	Vertical				
Number of Positions	24				
Number of Rows	2				
Electrical Characteristics					
Dielectric Withstanding Voltage (Max)	750 V				
Body Features					
Connector Profile	Standard				
Primary Product Color	Black				
Contact Features					
PCB Contact Termination Area Plating Material Thickness	3.5 µm				
Contact Shape & Form	Round				

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Contact Mating Area Plating Material Finish	Bright			
PCB Contact Termination Area Plating Material	Tin			
Contact Base Material	Phosphor Bronze			
Contact Mating Area Plating Material	Tin			
Contact Type	Pin			
Termination Features				
Termination Post & Tail Length	3.5 mm[.138 in]			
Termination Method to Printed Circuit Board	Through Hole - Solder			
Mechanical Attachment				
Mating Retention	With			
Panel Mount Feature	Without			
Mating Alignment	With			
Mating Alignment Type	Polarization			
PCB Mount Retention	Without			
PCB Mount Alignment	Without			
Connector Mounting Type	Board Mount			

Housing Features

Centerline (Pitch)	2.54 mm[.1 in]			
Housing Material	Thermoplastic			
Dimensions				
Row-to-Row Spacing	2.54 mm[.1 in]			
Usage Conditions				
Housing Temperature Rating	Standard			
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]			
Operation/Application				
Circuit Application	Power & Signal			
Packaging Features				
Packaging Quantity	400			
Packaging Type	Box, Carton			

Product Compliance

For compliance documentation, visit the product page on TE.com>

PCB Mount Header, Vertical, Board-to-Board, 24 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers



EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

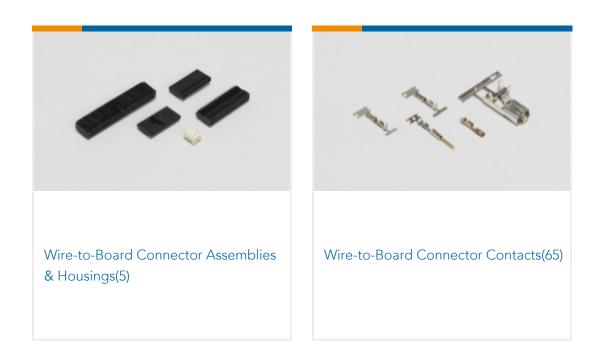


Also in the Series AMPMODU Headers

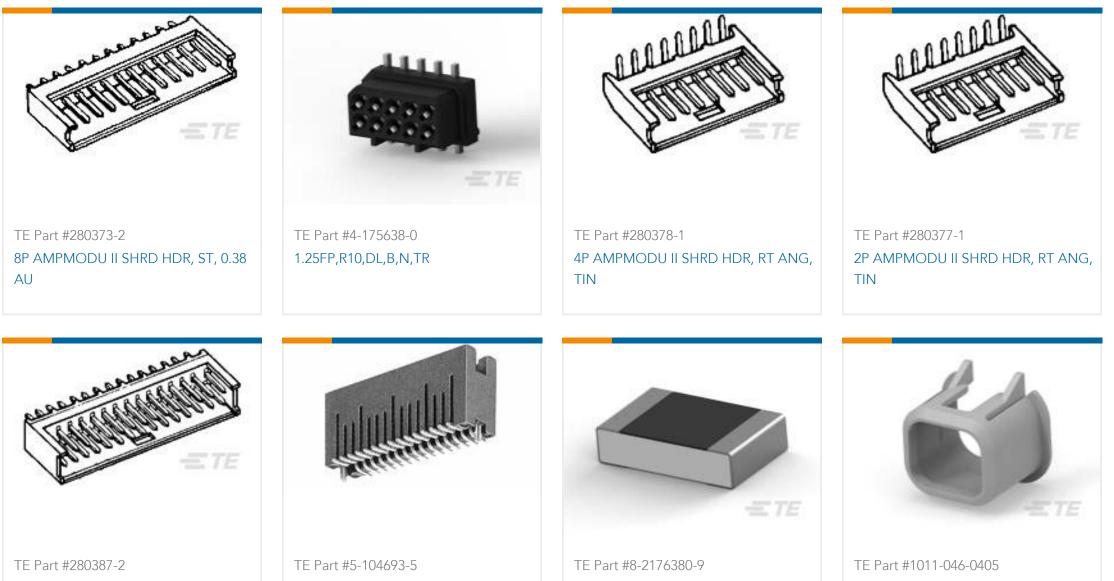


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Customers Also Bought



2X15P MODU II SHRD HDR, ST, 0.38AU	50 50/50 HDR DRST SFMNT.390 SN	RQ 0805 9K53 0.1% 10PPM 5K RL	SEAL RET, 4P, GRY, DTM

-	
TE Part #926498-1 KEYING PART	

Documents

Product Drawings 2X12P AMPMODU II SHRD HDR, ST, TIN

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_280521-1_T_c-280521-1-t.2d_dxf.zip

PCB Mount Header, Vertical, Board-to-Board, 24 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers



English

Customer View Model ENG_CVM_CVM_280521-1_T_c-280521-1-t.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_280521-1_T_c-280521-1-t.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance TE Material Declaration

English